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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



AS5130

8 Bit Programmable Magnetic Rotary Encoder with Motion Detection & Multiturn

1 General Description

The AS5130 is a contactless magnetic rotary encoder for accurate angular measurement over a full turn of 360°. It is a system-on-chip, combining integrated Hall elements, analog front end and digital signal processing in a single device. The angle can be measured using only a simple two-pole magnet rotating over the center of the chip. The magnet may be placed above or below the IC. The absolute angle measurement provides instant indication of the magnet's angular position with a resolution of 8 bit = 256 positions per revolution. This digital data is available as a serial bit stream and as a PWM signal. The AS5130 can be operated in pulsed mode ($V_{supply}=off$), which reduces the average power consumption significantly. During $V_{supply}=off$, the measured angle can be stored using an internal storage register supplied by a low power voltage line. This mode achieves very low power consumption during polling of the rotary position of the magnet. If the position of the magnet changes, then the motion detection feature wakes up an external system. The device is capable of counting the amount of magnet revolutions. The multi turn counter value is stored in a register and can be read in addition to the angle information. Furthermore, any arbitrary position can be set as zero-position. The system is tolerant to misalignment, air gap variations, temperature variations and external magnetic fields and high reliability due to non-contact sensing.

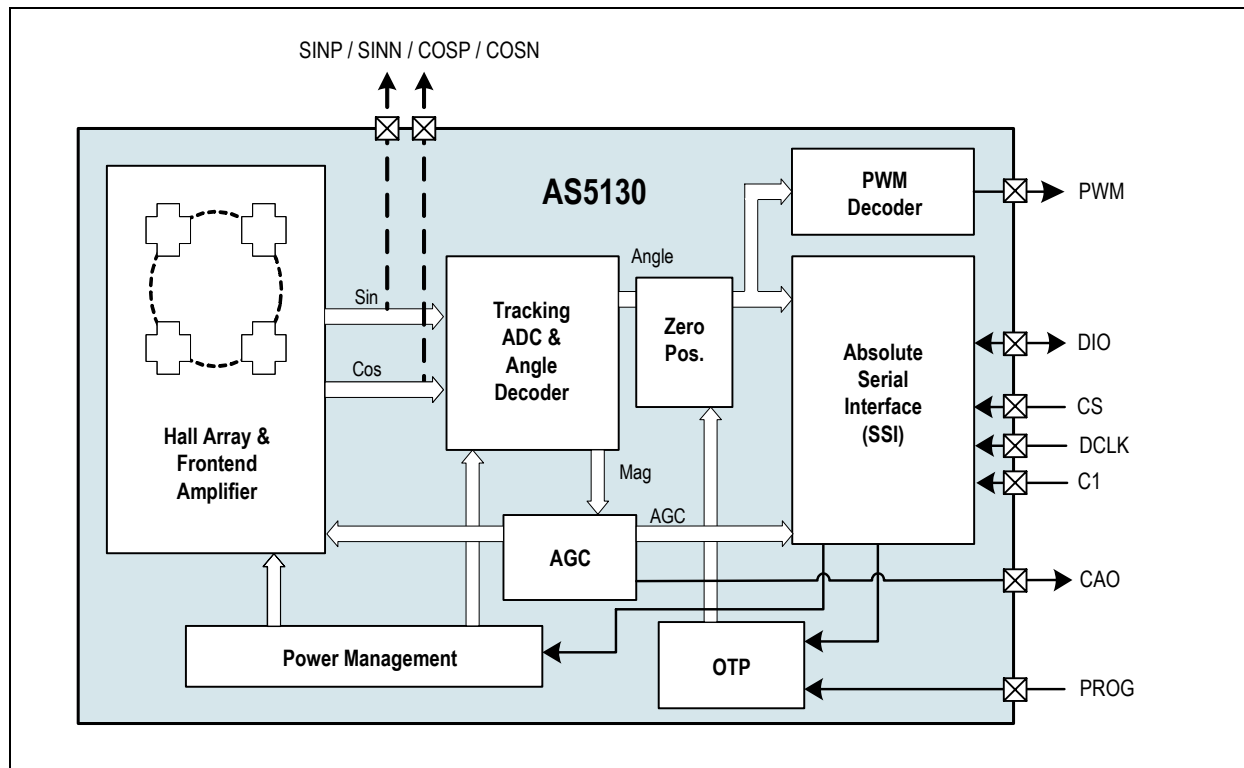
2 Key Features

- 360° contactless angular position encoding
- Two digital 8-bit absolute outputs:
 - Serial interface
 - Pulse width modulated (PWM) output
- User programmable zero position
- High speed: up to 30000 rpm
- Failure detection mode for magnet placement monitoring and loss of power supply
- Wide temperature range: - 40°C to +125°C
- Multi Turn counter / Movement detection
- Small Pb-free package: SSOP-16 (5.3mm x 6.2mm)
- Automotive qualified to AEC-Q100, grade 1

3 Applications

The AS5130 is an ideal solution for Ignition key position sensing, Steering wheel position sensing, Transmission gearbox encoder, Front panel rotary switches and replacement of Potentiometers.

Figure 1. AS5130 Block Diagram



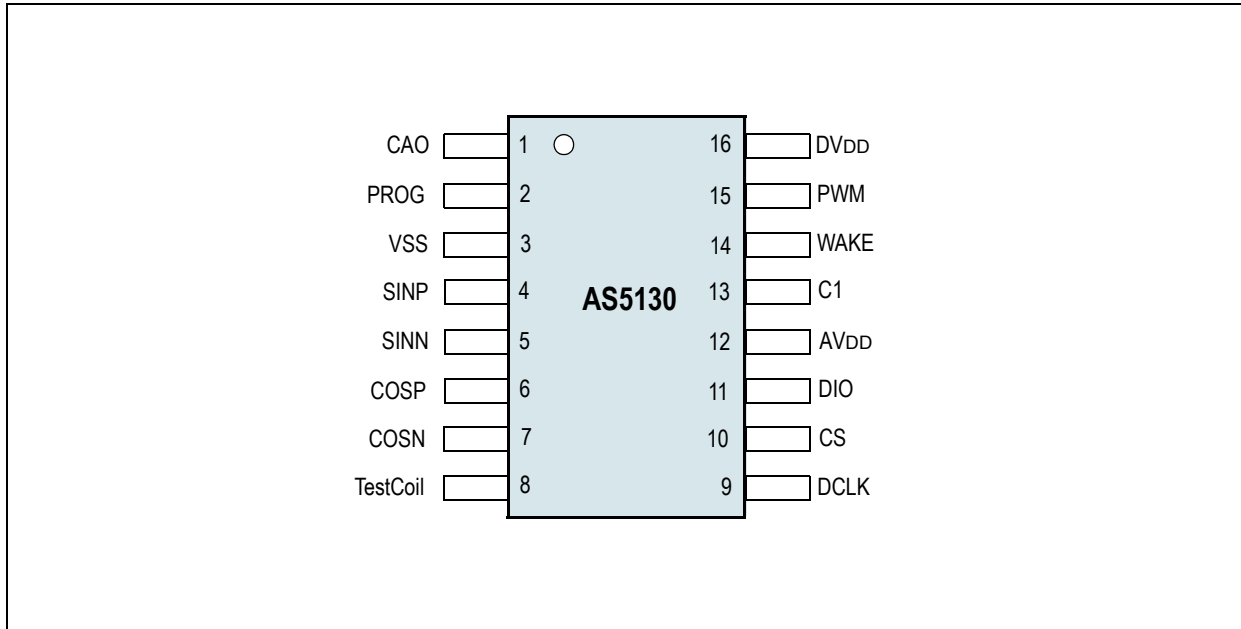
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4 Pin Assignments

Figure 2. Pin Assignments (Top View)



4.1 Pin Descriptions

Table 1. Pin Descriptions

Pin Name	Pin Number	Description
CAO	1	Indicates if the magnetic field is present. If the field is too low, the signal is HI.
PROG	2	OTP Programming Pad, programming voltage. For normal operation it must be left unconnected.
VSS	3	Supply Ground.
SINP	4	Used for factory testing. For normal operation it must be left unconnected.
SINN	5	Used for factory testing. For normal operation it must be left unconnected.
COSP	6	Used for factory testing. For normal operation it must be left unconnected.
COSN	7	Used for factory testing. For normal operation it must be left unconnected.
Test Coil	8	Test pin. Must be left unconnected.
DCLK	9	Clock Source for SSI communication. Schmitt trigger input.
CS	10	Chip Select for SSI. Active high. Schmitt trigger input.
DIO	11	Data input / output for SSI communication.
AVDD	12	Positive Supply Voltage 5V.
C1	13	Test mode selector. For normal operation it must be connected to VSS.
WAKE	14	Interrupt output. Used for polling mode. Open Drain NMOS. Use pull-up resistor with >1.5kΩ.
PWM	15	Pulse Width Modulation output. 0.5us width step per LSB.
DVDD	16	Pin to connect to low power supply for polling mode. Must be connected to VSS in normal mode.

5 Absolute Maximum Ratings

Stresses beyond those listed in [Table 2](#) may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in [Electrical Characteristics on page 6](#) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2. Absolute Maximum Ratings

Parameter	Min	Max	Units	Comments
Supply Voltage	0.3	7	V	Only relevant for polling operation mode, supply voltage with capacitor of the integrated storage register during t_{off} phase of AVDD
Input Pin Voltage	VSS-0.5	AVDD	V	
Input Current (latchup immunity)	-100	100	mA	Norm: EIA/JESD78 ClassII Level A
Electrostatic Discharge		± 2	kV	Norm: JESD22-A114E
Package Thermal Resistance SSOP-16	133	168	K/W	Still Air / Single Layer PCB
Storage Temperature	-55	125	°C	
Ambient Temperature	-40	125	°C	
Junction Temperature		150	°C	
Package body temperature		260	°C	Norm: IPC/JEDEC J-STD-020C. The reflow peak soldering temperature (body temperature) specified is in accordance with IPC/JEDEC J-STD-020C "Moisture/Reflow Sensitivity Classification for Non-Hermetic Solid State Surface Mount Devices". The lead finish for Pb-free leaded packages is matte tin (100% Sn).
Humidity non-condensing	5	85	%	

6 Electrical Characteristics

T_{AMB} = -40 to +125°C, unless otherwise noted.

Table 3. Electrical Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Units
AVDD	Positive Supply Voltage	Except OTP programming	4.5	5	5.5	V
DVDD	Polling Mode Supply Voltage		3.6	5	5.5	V
IDD	Power Supply Current		14		24	mA
I _{off}	Power Down Mode			1.4	2	mA
N	Resolution			8		bit
				1.406		
T _{PwrUp}	Power Up Time	Startup from zero			2000	μs
		Startup with preset AGC (Supplied during t _{off} phase of AVDD from the external buffer capacitor via DVDD pin)			250	
		Startup from sleep power mode			150	
t _{da}	Propagation Delay	Analog signal path; over full temperature range		15	17	μs
t _{dd}	Tracking rate	Step rate of tracking ADC; 1 step = 1.406°	0.85	1.15	1.45	μs
t _{delay}	Signal Processing Delay	Total signal processing delay, Analog + Digital + SSI readout (t _{da} + t _{dd} + t _{SSI})			21.55	μs
T	Analog filter time constant	Internal lowpass filter	4.1	6.6	12.5	μs
INL _{cm}	Accuracy	Centered Magnet	-2		2	
		Within horizontal displacement radius (see parameters for magnet)	-3		3	
TN	Transition Noise	rms (1 sigma)			0.235	
POR _r	Power-On-Reset levels	VDD rising	3.7	4	4.3	V
POR _f		VDD falling	3.4	3.7	3.9	V
Hyst		Hysteresis POR _r - POR _f			500	
Parameters for Magnet						
n	Rotational Speed	Frequencies above 1000 rpm causes an additional not specified DNL Error	-30000		30000	rpm
N	Resolution				8	bit
MD	Magnet diameter	Diametrically magnetized		6		mm
MT	Magnet thickness			2.5		mm
B _i	Magnetic input range	Valid for use of full range of sensitivity	32		75	mT
s	Magnetic Sensitivity of AGC	AGC value available at SSI	0.5		5	LSB/mT
B _{DC}	Magnetic Offset	Magnetic stray field without gradient			4	mT
T _{PwrUp}	Power up time	Startup from zero			2000	us
		Startup with preset AGC (Supplied during t _{off} phase of AVDD from the external buffer capacitor via DVDD pin)			250	
		Startup from sleep power mode			150	

Table 3. Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{out_wake\ up}$	Wake up output	Open drain output with tri-state behavior, see Fig 10			5	V
Wake _{LSB}	Angle difference threshold for wake up generation	Factory setting is 4 LSB, value is accessible by SSI in buffered register and can be changed by customer.	0		127	LSB
DC/AC Characteristics for Digital Inputs and Outputs						
CMOS Input						
V_{IH}	High level Input voltage		$0.7 \times V_{DD}$			V
V_{IL}	Low level Input Voltage				$0.3 \times V_{DD}$	V
I_{LEAK}	Input Leakage Current				1	μA
CMOS Output						
V_{OH}	High level Output voltage		$V_{DD} - 0.5$			V
V_{OL}	Low level Output Voltage				$V_{SS} + 0.4$	V
C_L	Capacitive Load				35	pF
t_{slew}	Slew Rate	External capacitive load $C_L = 35pF$ External series resistance $R = 0\Omega$ Junction temperature $T_J = 136^\circ C$ Rise time of the internal driver $t_{rise} = 3ns$ Fall time of the internal driver $t_{fall} = 3ns$			30	ns
t_{delay}	Time Rise Fall				15	ns
Programming Parameters						
V_{PROG}	Programming Voltage	static voltage at pin PROG	8.0		8.5	V
I_{PROG}	Programming Current				100	mA
$T_{ambPROG}$	Programming ambient temperature	during programming	0		85	$^\circ C$
t_{PROG}	Programming time	timing is internally generated	2		4	μs
$V_{R,prog}$	Analog readback voltage	during Analog Readback mode at pin PROG			0.5	V
$V_{R,unprog}$			2.2		3.5	
8-bit PWM output						
N_{PWM}	PWM resolution			8		bit
PW_{MIN}	PWM pulse width	angle = 0° (00 _H)	0.59	0.556	0.526	μs
PW_{MAX}	PWM pulse width	angle = 358.6° (FF _H)	150.9	142.3	134.61	μs
PW_P	PWM period	over full temperature range	151.5	142.8	135	μs
f_{PWM}	PWM frequency	= $1 / \text{PWM period}$	5.44	7	9.18	kHz
Hyst	Digital hysteresis	at change of rotation direction		1		bit
Serial 8-bit Output						
f_{CLK}	Clock Frequency	Normal operation			6	MHz
t_{CLK}			166.6			ns
$f_{CLK, P}$	Clock Frequency	During OTP programming	250		500	kHz

6.1 Timing Characteristics

T_{AMB} = -40 to 125°C, unless otherwise noted.

Table 4. Timing Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t ₀	Rising CLK to CS		15		--	ns
t ₁	Chip select to positive edge of CLK		15		--	ns
t ₂	Chip select to drive bus externally		--		--	ns
t ₃	Setup time command bit, Data valid to positive edge of CLK		30			ns
t ₄	Hold time command bit, Data valid after positive edge of CLK		30			ns
t ₅	Float time, Positive edge of CLK for last command bit to bus float		30		CLK/2	ns
t ₆	Bus driving time, Positive edge of CLK for last command bit to bus drive		CLK/2 +0		CLK/2 +30	ns
t ₇	Setup time data bit, Data valid to positive edge of CLK		CLK/2 +0		CLK/2 +30	ns
t ₈	Hold time data bit, Data valid after positive edge of CLK		CLK/2 +0		CLK/2 +30	ns
t ₉	Hold time chip select, Positive edge CLK to negative edge of chip select		30			ns
t ₁₀	Bus floating time, Negative edge of chip select to float bus		0		30	ns
t _{TO}	Timeout period in 2-wire mode (from rising edge of CLK)		20		24	µs

6.2 Magnetic Input Range

The magnetic input range is defined by the AGC loop. This regulating loop keeps the Hall sensor output in the optimum range for low SNR by adjusting the Hall bias current. This loop can adjust to a magnetic field strength variation of $\pm 38\%$. The AGC output voltage is an indicator for the magnetic field.

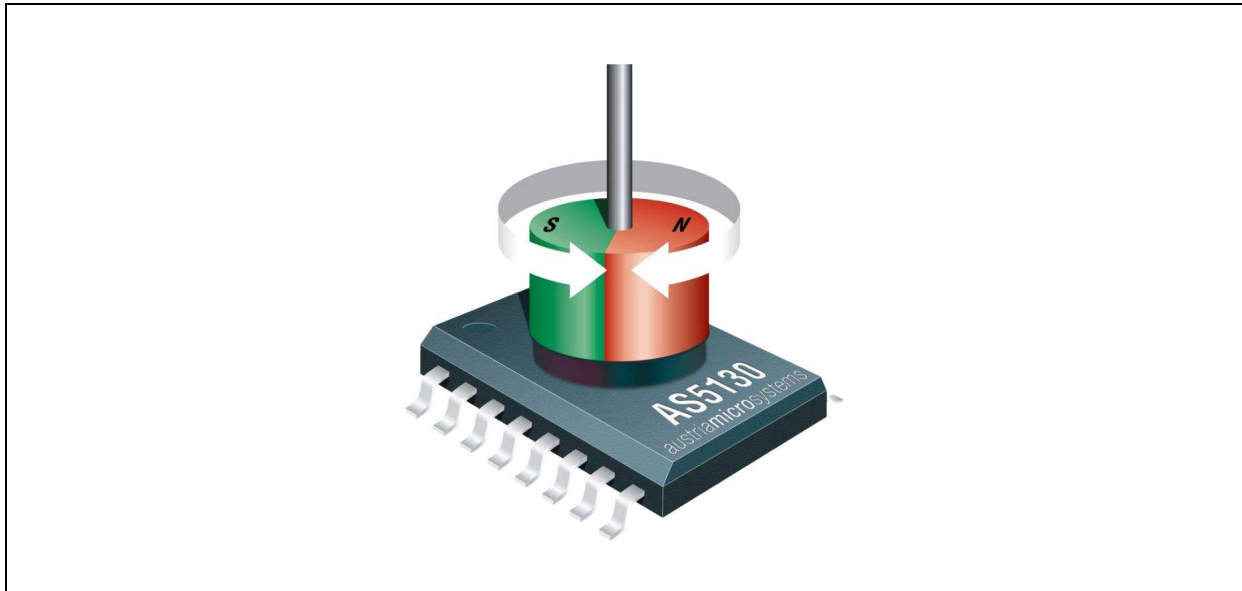
The nominal magnetic field for a balanced AGC is defined by the Hall bias and the Hall sensitivity and can be set by a variable gain in the signal path. The gain can be set in 8 steps in the OTP or by the SSI in a mirror register. The resulting magnetic input range is a value of $B_{\text{nominal}} \pm 38\%$ inside of a range of 32mT ... 75mT, if the trimming is performed by the customer.

Table 5. Magnetic Input Range

Setting	0	1	2	3	4	5	6	7
Binary	000	001	010	011	100	101	110	111
Gain A	0.9	1.05	1.2	1.4	1.65	1.9	2.2	2.55
B _{limit}	Max. 75mT							Min. 32mT

7 Detailed Description

Figure 3. Typical Arrangement of AS5130 and Magnet



7.1 Connecting the AS5130

The AS5130 can be connected to an external controller in several ways as listed below:

- Serial 3-wire connection (default setting)
- Serial 3-wire connection (OTP programming option)
- 1-wire PWM connection
- Analog output
- Analog Sin/Cos outputs with external interpolator

7.1.1 Serial 3-Wire Connection (Default Setting)

In this mode, the AS5130 is connected to the external controller via three SSI signals: Chip Select (CS), Clock (CLK) input and DIO (Data) in/output. This configuration not only helps to read and write data but also defines different operation modes. The data transfer in all cases is done via the DIO port.

Figure 4. Standard SSI Serial Data Interface

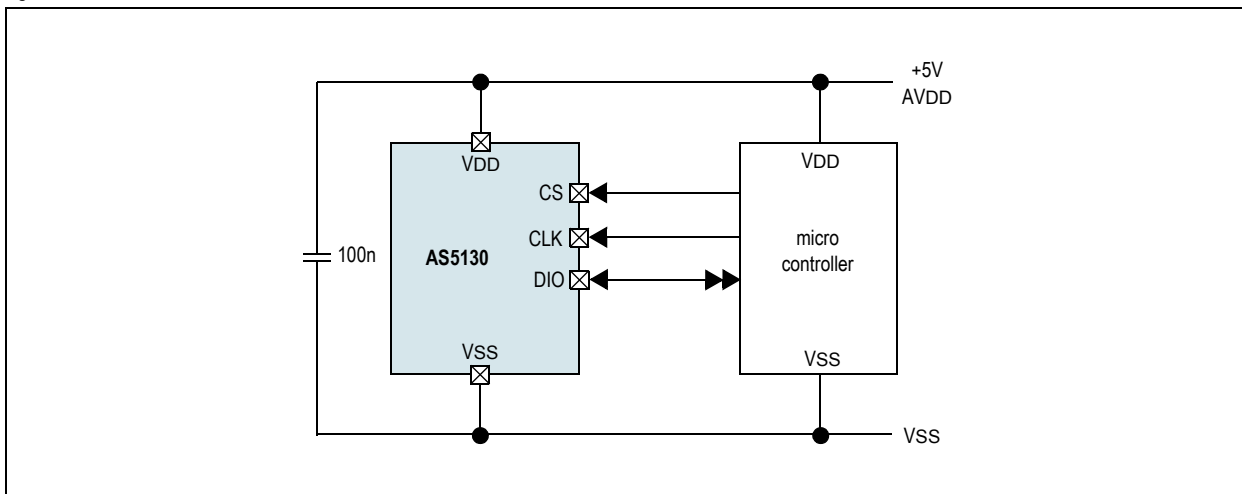


Figure 5. Normal Operation Mode

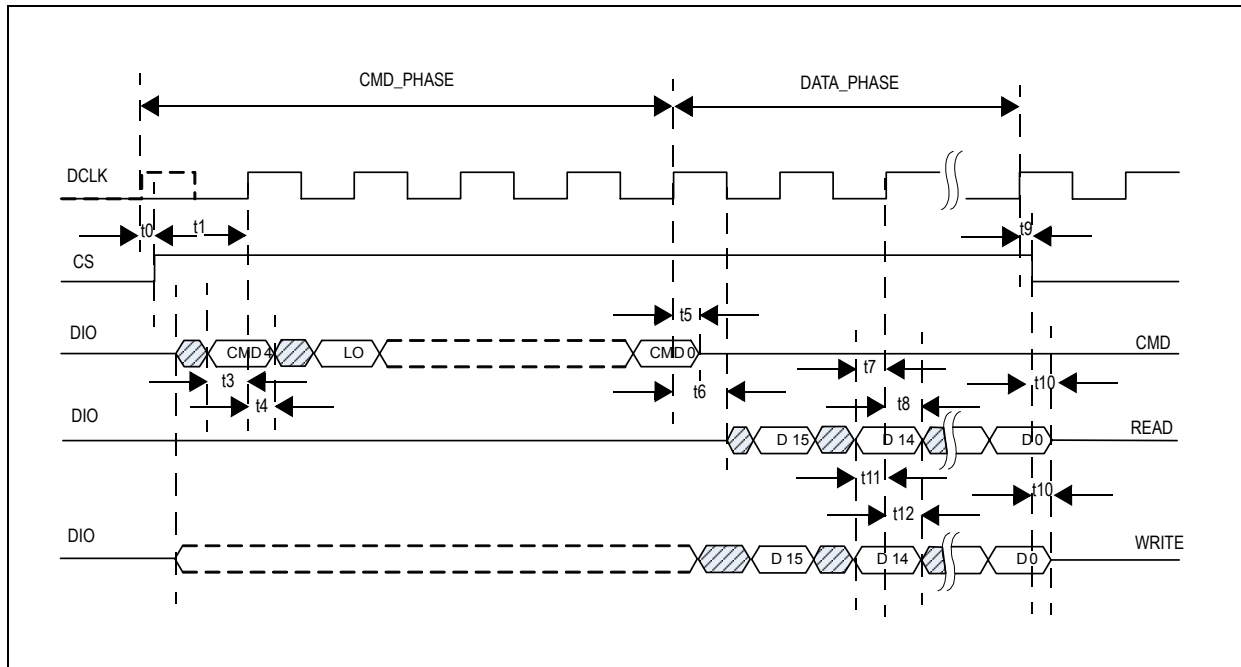


Table 6. Serial Bit Sequence (16bit read/write)

Write Command					Read/Write Data															
C4	C3	C2	C1	C0	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

Figure 6. Extended Operation Mode (for access of OTP only)

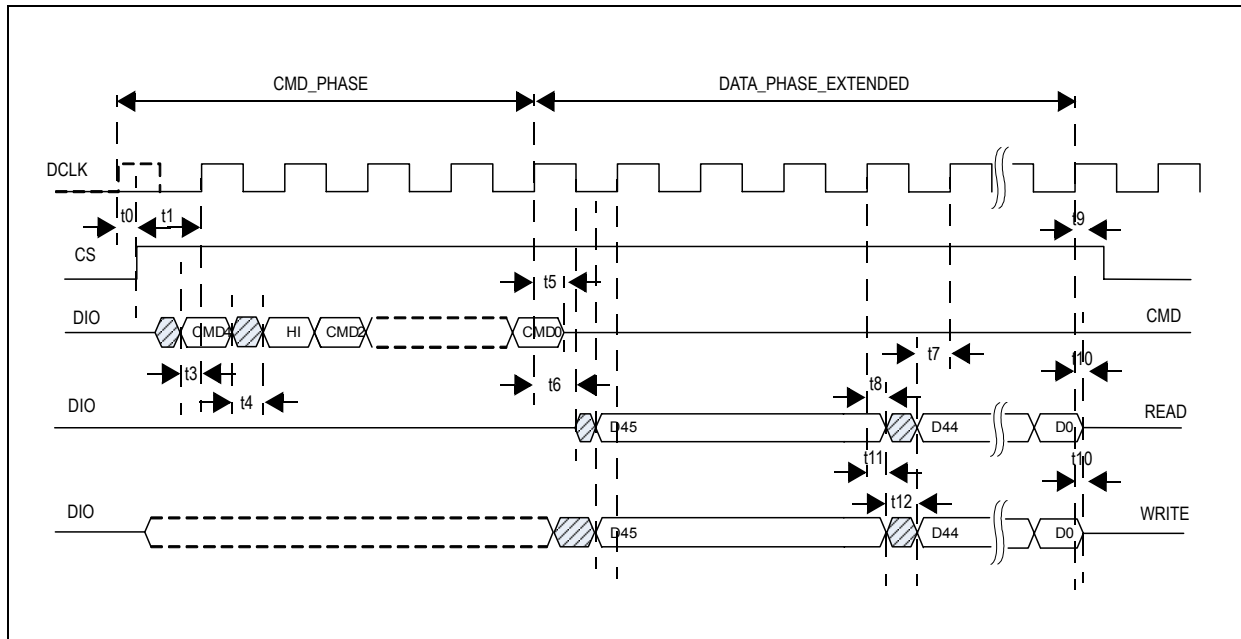


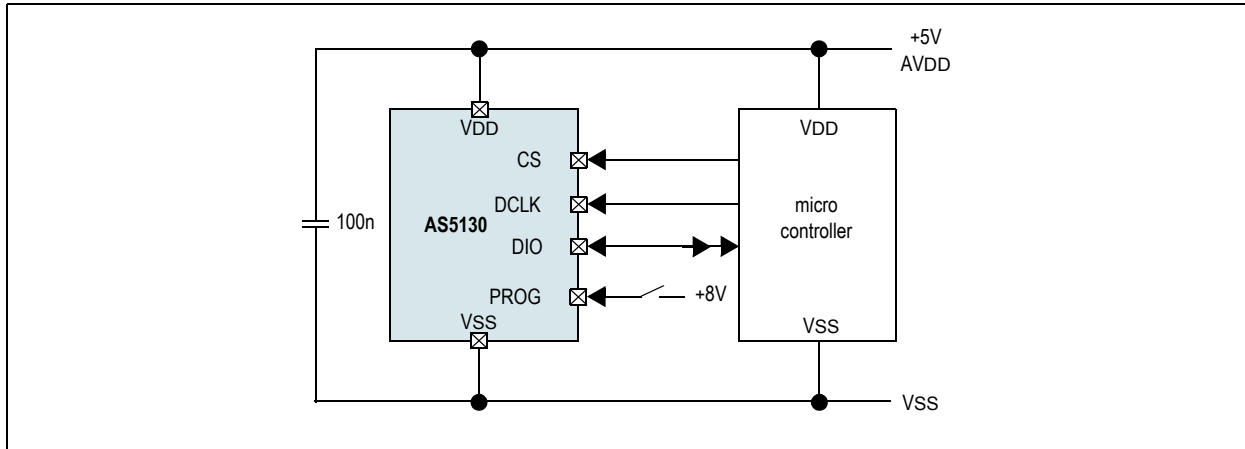
Table 7. Serial Bit Sequence (16bit read/write)

Write Command					Read/Write Data															
C4	C3	C2	C1	C0	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0

7.1.2 Serial 3-Wire Connection (OTP Programming Option)

This mode provides with an option to configure the serial interface for programming the OTP register. Using a clock input (CLK), DIO (Data) in/output and CS pin, it is possible to write and read out data from the OTP Register. The data transfer is done via the DIO channel. For programming, the PROG pin must be connected to +8V. Analog readout for trimming verification is mandatory.

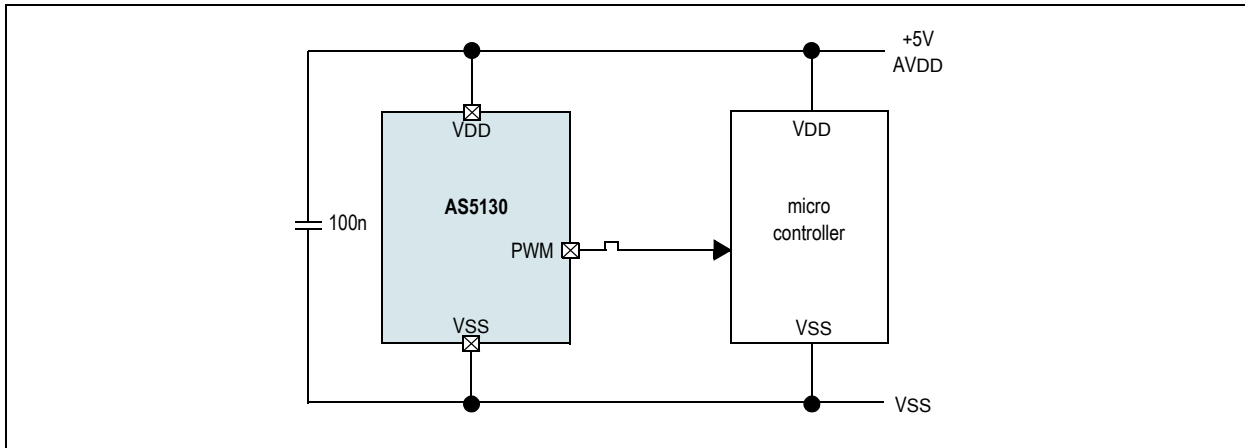
Figure 7. Serial Data Transmission in Continuous Readout Mode



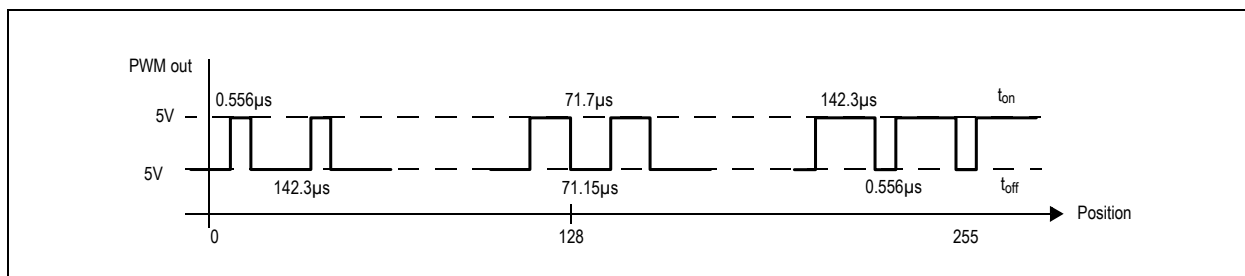
7.1.3 1-Wire PWM Connection

If the line (PWM) is used as angle output, the total number of connections can be reduced to three, including the supply lines. This type of configuration is especially useful for remote sensors. Low power mode is not possible in this configuration. If the AS5130 angular data is invalid, the PWM output will remain at low state.

Figure 8. Data Transmission with Pulse Width Modulated (PWM) Output



The minimum PWM pulse width t_{ON} (PWM = high) is 1 LSB @ 0° (Angle reading = 00_H). 1LSB = nom. $.0.556\mu s$. The PWM pulse width increases with 1LSB per step. At the maximum angle 358.6° (Angle reading = FF_H), the pulse width t_{ON} (PWM = high) is 256 LSB and the pause width t_{OFF} (PWM = low) is 1 LSB. This leads to a total period ($t_{ON} + t_{OFF}$) of 257LSB.



Position	Angle	High	t_high	Low	t_low	Duty-Cycle
0	0°	1	0,556	256	142,3	0.39%
127	178.59	128	71,15µs	129	71,7µs	49.4%
128	180°	129	71,7µs	128	71,15µs	50.2%
255	358.59°	256	142,3µs	1	0,556µs	99.6%

This means that the PWM pulse width is (position + 1) LSB, where position is 0...255.

The tolerance of the absolute pulse width and frequency can be eliminated by calculating the angle with the duty cycle rather than with the absolute pulse width:

$$\text{angle [8 - bit]} = \left(257 \frac{t_{ON}}{t_{ON} + t_{OFF}} \right) - 1 \quad (\text{EQ 1})$$

results in an 8-bit value from 00_H to FF_H,

$$\text{angle [}^\circ \text{]} = \frac{360}{256} \left[\left(257 \frac{t_{ON}}{t_{ON} + t_{OFF}} \right) - 1 \right] \quad (\text{EQ 2})$$

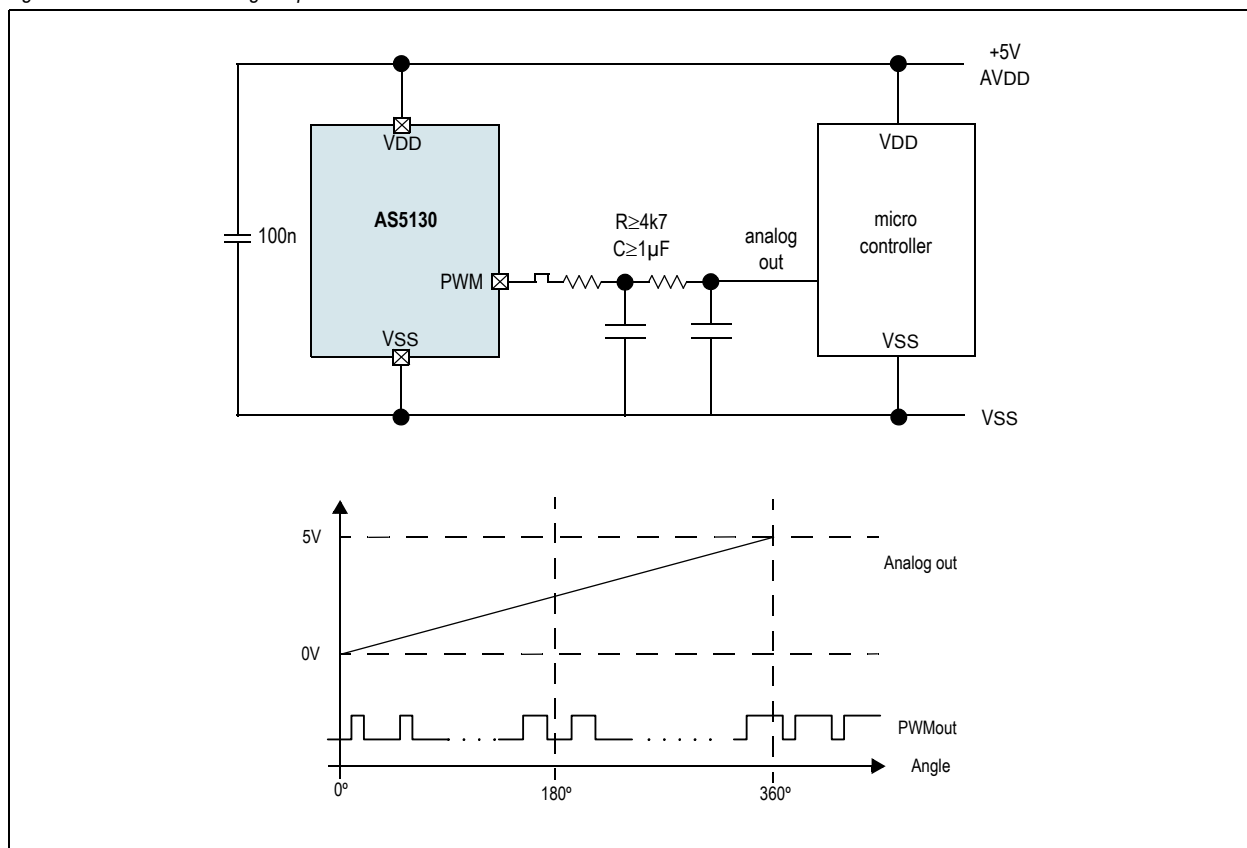
results in a degree value from 0° ...358.6°

Note: The absolute frequency tolerance is eliminated by dividing t_{ON} by $(t_{ON} + t_{OFF})$, as the change of the absolute timing effects both T_{ON} and T_{OFF} in the same way.

7.1.4 Analog Output

The AS5130 can generate a ratiometric analog output voltage by low-pass filtering the PWM output. Figure 9 shows a simple passive 2nd order low pass filter as an example. In order to minimize the ripple on the analog output, the cut-off frequency of the low pass filter should be well below the PWM base frequency.

Figure 9. Ratiometric Analog Output



7.1.5 Analog Sin/Cos Outputs with External Interpolator

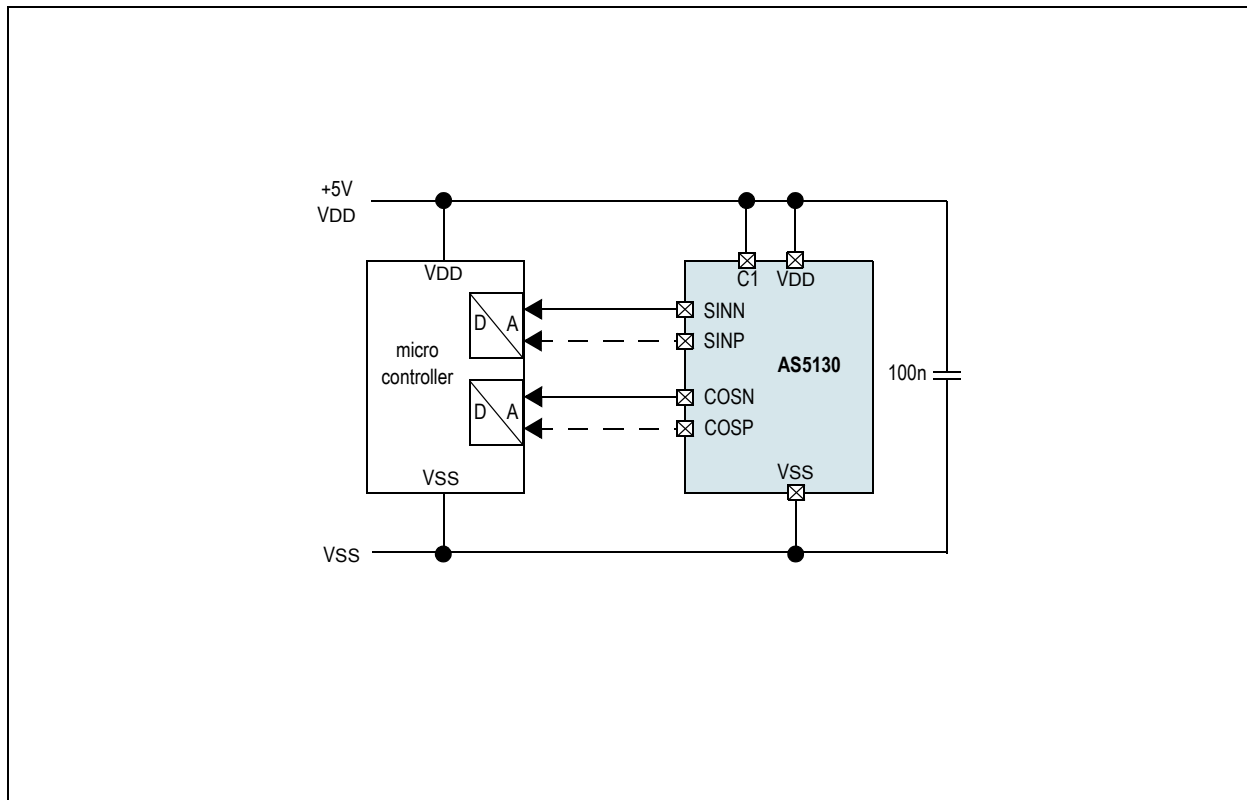
By connecting C1 to VDD, the AS5130 provides analog Sine and Cosine outputs (SINP, COSP) of the Hall array front-end for test purposes. These outputs allow the user to perform the angle calculation by an external ADC + μC , e.g. to compute the angle with a high resolution. In addition, the inverted Sinus and Cosine signals (SINN, COSN; see dotted lines) are available for differential signal transmission.

The input resistance of the receiving amplifier or ADC should be greater than $100\text{k}\Omega$. The signal lines should be kept as short as possible, longer lines should be shielded in order to achieve best noise performance.

The SINN / COSN / SINP / COSP signals are amplitude controlled to $\sim 1.3\text{Vp}$ (differential) by the internal AGC controller. The DC bias voltage is 2.25V .

If the SINN and COSN outputs cannot be sampled simultaneously, it is recommended to disable the automatic gain control (see Table 8) as the signal amplitudes may be changing between two readings of the external ADC. This may lead to less accurate results.

Figure 10. Sine and Cosine Outputs for External Angle Calculation



7.2 Serial Synchronous Interface (SSI)

7.2.1 Commands of the SSI in Normal Mode

Table 8. SSI in Normal Mode

#	cmd	bin	mode	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
23	WRITE CUST	10111	write	wlsb_6	wlsb_5	wlsb_4	wlsb_3	wlsb_2	wlsb_1	wlsb_0	gain_2	gain_1	gain_0	nc	nc	nc	nc	nc	nc	
22	WD2COS	10110	write	xen_7	inv_7	xen_6	inv_6	xen_5	inv_5	xen_4	inv_4	xen_3	inv_3	xen_2	inv_2	xen_1	inv_1	xen_0	inv_0	
21	SET TEST CFG1	10101	write						gen_rst											
20	reserved	10100	write																	
19	HYST_RST	10011	write	rst_otp	nc	rst_multi	nc	setHyst												
18	WD2SIN	10010	write	xen_7	inv_7	xen_6	inv_6	xen_5	inv_5	xen_4	inv_4	xen_3	inv_3	xen_2	inv_2	xen_1	inv_1	xen_0	inv_0	
17	WRITE CONFIG	10001	write	go2sleep																
16	--	10000	write																	
7	READ CUST	00111	read	wlsb_6	wlsb_5	wlsb_4	wlsb_3	wlsb_2	wlsb_1	wlsb_0	gain_2	gain_1	gain_0	nc	nc	nc	nc	nc	parity	
6	RD2COS	00110	read	xen_7	inv_7	xen_6	inv_6	xen_5	inv_5	xen_4	inv_4	xen_3	inv_3	xen_2	inv_2	xen_1	inv_1	xen_0	inv_0	
5		00101	read																	
4	RD_BOTH	00100	read	Multiturn <7:0>								angle <7:0>								
3	STORE REF	00011	read	store_ok	vdd_ok	reg_set	nc	nc	nc	nc	angle_stored <7:0>								parity	
2	RD2SIN	00010	read	xen_7	inv_7	xen_6	inv_6	xen_5	inv_5	xen_4	inv_4	xen_3	inv_3	xen_2	inv_2	xen_1	inv_1	xen_0	inv_0	
1	RD_MULTI	00001	read	lock	agc <5:0>					Multiturn <7:0>					parity					
0	RD_ANGLE	00000	read	lock	agc <5:0>					angle <7:0>					parity					

WD2COS / WD2SIN: xen_X disables Hall element X from the sensor array in the cosine or sine channel; xinv_X inverts the voltage output of Hall element X in the channels.

RD2COS / RD2SIN: The Hall array configuration for cosine and sine channel can be read out by these commands, initial values are 0.

SET TEST CFG 1: gen_rst HI triggers a digital reset.

WRITE CONFIG: go2sleep HI activates the sleep mode of the AS5130. The power consumption is significantly reduced. go2sleep LO returns to normal operation mode. During sleep mode, the lock bit in command 0 and command 1 is LO.

WRITE CUST: With "wlsb_x" the threshold level for generation of a WAKE pulse is set (only important in polling mode). The initial value is 4 LSB. No value lower than 4 LSB can be set. The maximum value is 127 LSB.

"gain_x" sets the gain in the signal

HYST_RST: "setHyst" enables an additional hysteresis of the digital output signal. It is enabled by default. Only after 2 consecutive equal signals the output is changed.

"rst_otp" forces the IC to read out the OTP in polling mode. This reset has to be performed after initial startup and every WAKE signal.

"rst_multi" resets the multi turn counter to 0.

READ CUST: With this command "wlsb_x" and "gain_x" can be read out.

RD_BOTH: Angle and multi turn counter value can be read out simultaneously by this command. Due to limited data size, the parity bit is not available in this command.

STORE REF: This command stores the actual angle as reference angle in the storage registers (only important in polling mode). The output is the stored angle (angle_stored), a flag, if the voltage at DVDD is OK (store_ok), a flag, if the supply voltage is OK (vdd_ok) and a check bit, if the register was written.

RD_MULTI: Command for read out of multi turn register (multiturn) and AGC value (agc). "Lock" indicates a locked ADC and "parity" an even parity checksum.

RD_ANGLE: Command for read out of angle value and AGC value (agc). "Lock" indicates a locked ADC and "parity" an even parity checksum.

7.2.2 Commands of the SSI in Extended Mode

For programming or readout of the OTP data, the chip has to be started with DVDD at a low voltage (polling mode off or cap discharged) or the OTP reset has to be performed. If not, the OTP is not read out and the OTP data is not available.

Table 9. SSI in Extended Mode

#	cmd	bin	mode	<45:44>	<43:32>	<31:28>	<27:26>	<25>	<24:23>	<22:20>	<19:16>	<15:12>	<11:9>	<8>	<7:0>
31	WRITE_OTP	11111	xt write	OTP Test	ID			OTP lock	VREF	Hall Bias	Osc	Redundancy	Sensitivity	Wake enable	Zero Angle
30		11110	xt write												
29		11101	xt write												
28		11100	xt write												
27		11011	xt write												
26		11010	xt write												
25	PROG_OTP	11001	xt write	OTP Test	ID			OTP lock	VREF	Hall Bias	Osc	Redundancy	Sensitivity	Wake enable	Zero Angle
24		11000	xt write												
15		01111	xt read	OTP Test	ID			OTP lock	VREF	Hall Bias	Osc	Redundancy	Sensitivity	Wake enable	Zero Angle
14		01110	xt read												
13		01101	xt read												
12		01100	xt read												
11		01011	xt read												
10		01010	xt read												
9	RD_OTP_ANA	01001	xt read												
8		01000	xt read												

WRITE_OTP: Writing of the OTP register. The written data is volatile. “Zero Angle” is the angle, which is set for zero position. “Wake enable” enables the polling mode. “Sensitivity” is the gain setting in the signal path. “Redundancy is a number of bits, which allows the customer to overwrite one of the customer OTP bits <0:11>.

PROG_OTP: Programming of the OTP register. Only Bits <0:15> can be programmed by the customer.

RD_OTP: Read out the content of the OTP register. Data written by WRITE_OTP and PROG_OTP is read out.

RD_OTP_ANA: Analog read out mode. The analog value of every OTP bit is available at pin 2 (PROG), which allows for a verification of the fuse process. No data is available at the SSI.

7.2.2.1 OTP Programming

For programming of the OTP, an additional voltage has to be applied to the pin PROG. It has to be buffered by a fast 100nF capacitor (ceramic) and a 10µF capacitor. The information to be programmed is set by command 25. The OTP bits 16 to 45 are used for AMS factory trimming and cannot be overwritten.

Figure 11. OTP Programming Connection

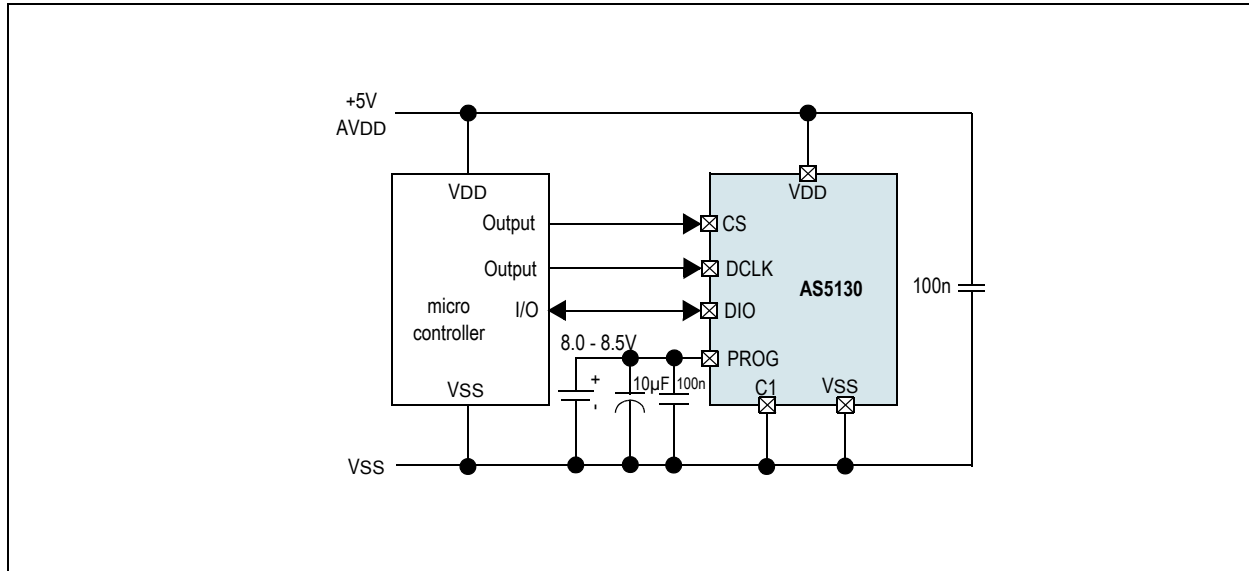
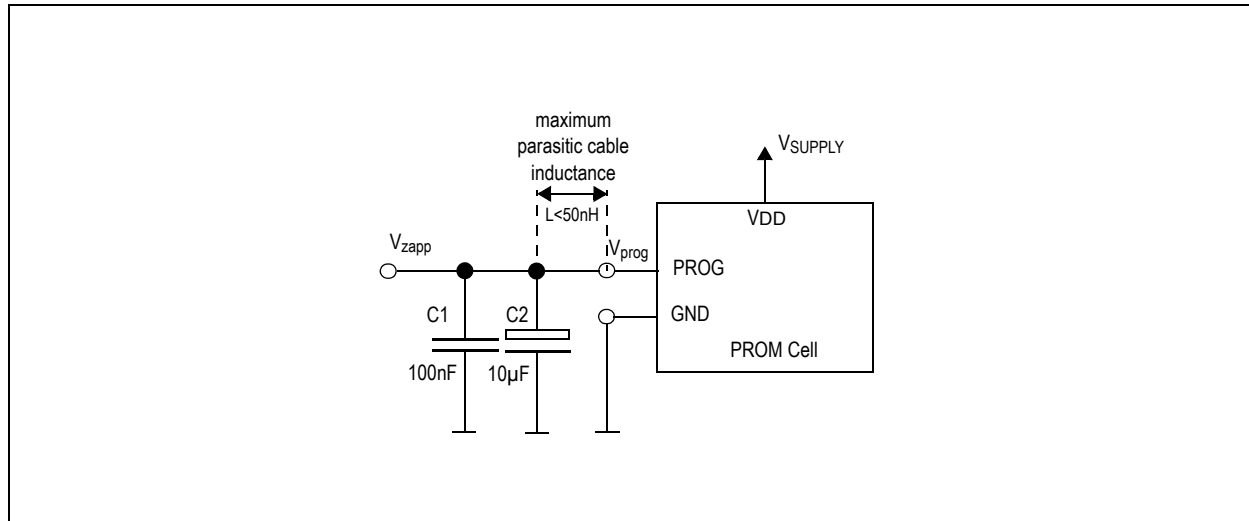


Figure 12. External Circuitry for OTP Programming



Symbol	Parameter	Min	Max	Unit	Notes
V _{DD}	Supply Voltage	5	5.5	V	
GND	Ground Level	0	0	V	
V _{zapp}	Programming Voltage	8	8.5	V	At pin PROG
T _{zapp}	Temperature	0	85	°C	
f _{clk}	CLK Frequency		100	kHz	At pin DCLK

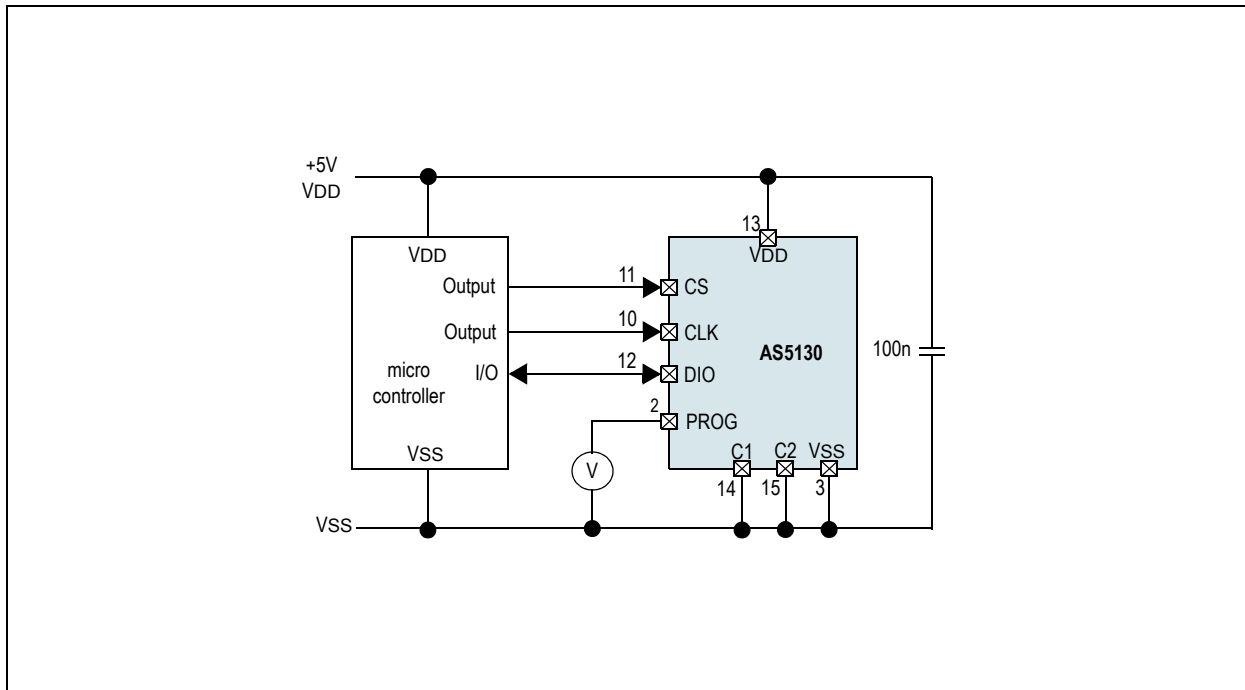
7.2.2.2 Programming Verification

After programming, the programmed OTP bits are verified in following two ways:

By Digital Verification: This is simply done by sending a READ OTP command (#0FH, Refer to Table 9). The structure of this register is the same as for the OTP PROG or OTP WRITE commands.

By Analog Verification: By sending an ANALOG OTP READ command (#09H), pin PROG becomes an output, sending an analog voltage with each clock, representing a sequence of the bits in the OTP register. A voltage of <math>< 500\text{mV}</math> indicates a correctly programmed bit ("1") while a voltage level between 2.2V and 3.5V indicates a correctly unprogrammed bit ("0"). Any voltage level in between indicates improper programming.

Figure 13. Analog OTP Verification



Redundancy Decoding. If a bit is not fused properly (analog readout levels violated), the redundancy bits can be used as shown in the table below. Only one single bit can be overwritten with a logic HI. An improper fusing cannot be made undone.

<15:12>	replaced bit		<15:12>	replaced bit
0000	none		1000	7
0001	0		1001	8
0010	1		1010	9
0011	2		1011	10
0100	3		1100	11
0101	4		1101	none
0110	5		1110	none
0111	6		1111	none

7.3 Multi Turn Counter

An 8-bit register is used for counting the magnet's revolutions. With each zero transition in any direction, the output of a special counter is incremented or decremented. The initial value after reset is 0 LSB.

The multi turn value is encoded as complement on two. Clockwise rotation gives increasing angle values and positive turn count. Counter clockwise rotation exhibits decreasing angle values and a negative turn count respectively.

Bit Code	Decimal Value
01111111	127
---	---
00000011	+3
00000010	+2
00000001	+1
00000000	0
11111111	-1
11111110	-2
11111101	-3
---	---
10000000	-128

The counter output can be reset by using command 19 – HYST_RST. It is immediately reset by the rising clock edge of this bit. Any zero crossing between the clock edge and the next counter readout changes the counter value.

7.4 AS5130 Status Indicators

7.4.1 Lock Status Bit

The Lock signal indicates whether the angle information is valid (ADC locked, Lock = high) or invalid (ADC unlocked, Lock = low). To determine a valid angular signal at best performance, the following indicators should be set:

Lock = 1

AGC = >00H and < 2FH

Note: The angle signal may also be valid (Lock = 1), when the AGC is out of range (00H or 2FH), but the accuracy of the AS5130 may be reduced due to the out of range condition of the magnetic field strength.

7.4.2 Magnetic Field Strength Indicators

The AS5130 is not only able to sense the angle of a rotating magnet, it can also measure the magnetic field strength (and hence the vertical distance) of the magnet. This additional feature can be used for several purposes:

- as a safety feature by constantly monitoring the presence and proper vertical distance of the magnet
- as a state-of-health indicator, e.g. for a power-up self test
- as a pushbutton feature for rotate-and-push types of manual input devices

The magnetic field strength information is available in two forms – Magnetic field strength hardware indicator and Magnetic field strength software indicator.

Magnetic Field Strength Hardware Indicator. Pin CAO (#1) will be low, when the magnetic field is too weak. The switching limit is determined by the value of the AGC. If the AGC value is <3FH, the CAO output will be high (green range), If the AGC is at its upper limit (3FH), the CAO output will be low (red range).

Magnetic Field Strength Software Indicator. D13:D7 in the serial data that is obtained by command READ ANGLE (see Table 8) contains the 6-bit AGC information. The AGC is an automatic gain control that adjusts the internal signal amplitude obtained from the Hall elements to a constant level. If the magnetic field is weak, e.g. with a large vertical gap between magnet and IC, with a weak magnet or at elevated temperatures of the magnet, the AGC value will be high. Likewise, the AGC value will be lower when the magnet is closer to the IC, when strong magnets are used and at low temperatures.

The best performance of the AS5130 will be achieved when operating within the AGC range. It will still be operational outside the AGC range, but with reduced performance especially with a weak magnetic field due to increased noise.

Factors Influencing the AGC Value. In practical use, the AGC value will depend on several factors:

- **The initial strength of the magnet.** Aging magnets may show a reducing magnetic field over time which results in an increase of the AGC value. The effect of this phenomenon is relatively small and can easily be compensated by the AGC.
- **The vertical distance of the magnet.** Depending on the mechanical setup and assembly tolerances, there will always be some variation of the vertical distance between magnet and IC over the lifetime of the application using the AS5130. Again, vertical distance variations can be compensated by the AGC.
- **The temperature and material of the magnet.** The recommended magnet for the AS5130 is a diametrically magnetized 6mm diameter magnet. Other magnets may also be used as long as they can maintain to operate the AS5130 within the AGC range. Every magnet has a temperature dependence of the magnetic field strength. The temperature coefficient of a magnet depends on the used material. At elevated temperatures, the magnetic field strength of a magnet is reduced, resulting in an increase of the AGC value. At low temperatures, the magnetic field strength is increased, resulting in a decrease of the AGC value. The variation of magnetic field strength over temperature is automatically compensated by the AGC.

OTP Sensitivity Adjustment. To obtain best performance and tolerance against temperature or vertical distance fluctuations, the AGC value at normal operating temperature should be in the middle between minimum and maximum, hence it should be around 32 (20H). To facilitate the "vertical centering" of the magnet+IC assembly, the sensitivity of the AS5130 can be adjusted in the OTP register in 8 steps (see Table 9). The OTP sensitivity setting corresponds to the customer register setting gain <2:0>.

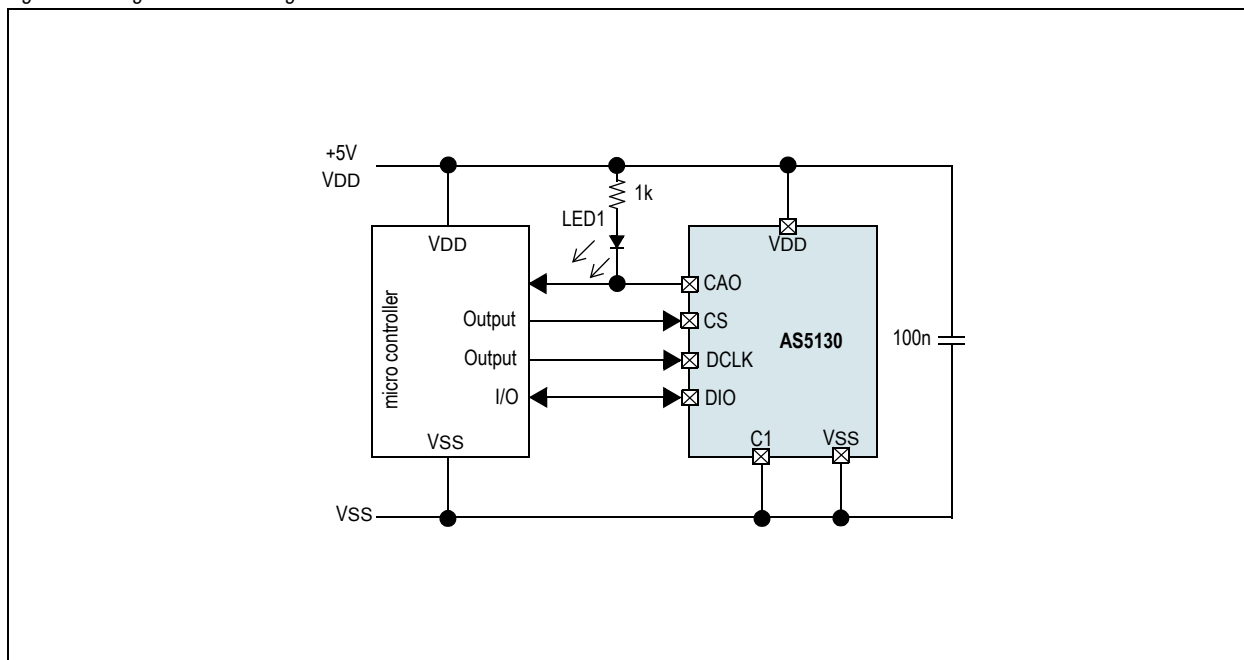
7.5 "Pushbutton" Feature

Using the magnetic field strength software and hardware indicators described above, the AS5130 provides a useful method of detecting both rotation and vertical distance simultaneously. This is especially useful in applications implementing a rotate-and-push type of human interface (e.g. in panel knobs and switches).

The CAO output is low, when the magnetic field is below the low limit (weak or no magnet) and high when the magnetic field is above the low limit (in-range or strong magnet).

A finer detection of a vertical distance change, for example when only short vertical strokes are made by the pushbutton, is achieved by memorizing the AGC value in normal operation and triggering on a change from that nominal the AGC value to detect a vertical movement.

Figure 14. Magnetic Field Strength Indicator



7.6 High Speed Operation

The AS5130 is using a fast tracking ADC (TADC) to determine the angle of the magnet. The TADC has a tracking rate of 1.15µs (typ).

Once the TADC is synchronized with the angle, it sets the LOCK bit in the status register (see Table 8). In worst case, usually at start-up, the TADC requires a maximum of 127 steps ($127 * 1.15\mu\text{s} = 146,05\mu\text{s}$) to lock. Once it is locked, it requires only one cycle (1.15µs) to track the moving magnet.

The AS5130 can operate in locked mode at rotational speeds up to 30,000 rpm.

In Low Power Mode, the position of the TADC is frozen. It will continue from the frozen position once it is powered up again. If the magnet has moved during the power down phase, several cycles will be required before the TADC is locked again. The tracking time to lock in with the new magnet angle can be roughly calculated as:

$$t_{\text{LOCK}} = 1.15\mu\text{s} * |\text{NewPos} - \text{OldPos}| \quad (\text{EQ } 3)$$

Where:

t_{LOCK} = time required to acquire the new angle after power up from one of the reduced power modes [µs]

OldPos = Angle position when one of the reduced power modes is activated [°]

NewPos = Angle position after resuming from reduced power mode [°]

7.6.1 Propagation Delay

The Propagation delay is the time required from reading the magnetic field by the Hall sensors to calculating the angle and making it available on the serial or PWM interface. While the propagation delay is usually negligible on low speeds, it is an important parameter at high speeds. The longer the propagation delay, the larger becomes the angle error for a rotating magnet as the magnet is moving while the angle is calculated. The position error increases linearly with speed. The main factors that contribute to the propagation delay are discussed in detail further in this document.

7.6.2 Sampling Rate

For high speed applications, fast ADC's are essential. The ADC sampling rate directly influences the propagation delay. The fast tracking ADC used in the AS5130 with a tracking rate of only 1.15µs (typ) is a perfect fit for both high speed and high performance.

7.6.3 Chip Internal Lowpass Filtering

A commonplace practice for systems using analog-to-digital converters is to filter the input signal by an anti-aliasing filter. The filter characteristic must be chosen carefully to balance propagation delay and noise. The lowpass filter in the AS5130 has a cutoff frequency of typ. 23.8kHz and the overall propagation delay in the analog signal path is typ. 15.6µs.

7.6.4 Digital Readout Rate

Aside from the chip-internal propagation delay, the time required to read and process the angle data must also be considered. Due to its nature, a PWM signal is not very usable at high speeds, as you get only one reading per PWM period. Increasing the PWM frequency may improve the situation but causes problems for the receiving controller to resolve the PWM steps. The frequency on the AS5130 PWM output is typ. 1.95kHz with a resolution of 2µs/step. A more suitable approach for high speed absolute angle measurement is using the serial interface. With a clock rate of up to 6MHz, a complete set of data (21bits) can be read in >3.5µs.

7.6.5 Total Propagation Delay of the AS5130

The total propagation delay of the AS5130 is the delay in the analog signal path and the tracking rate of the ADC:

$$15.6\mu\text{s} + 1.15\mu\text{s} = 16.75\mu\text{s} \quad (\text{EQ } 4)$$

If only the SIN-/COS-outputs are used, the propagation delay is the analog signal path delay only (typ. 15.6µs).

Position Error Over Speed: The angle error over speed caused by the propagation delay is calculated as:

$$\Delta\theta_{pd} = \text{rpm} * 6 * 16.75E^{-6} \text{ in degrees} \quad (\text{EQ } 5)$$

In addition, the anti-aliasing filter causes an angle error calculated as:

$$\Delta\theta_{pf} = \text{ArcTan} [\text{rpm} / (60*f_0)] \quad (\text{EQ } 6)$$

Table 10. Examples of the Overall Position Error caused by Speed (includes both propagation delay and filter delay)

Speed (rpm)	Total Position Error ($\Delta\theta_{pd} + \Delta\theta_{pf}$)
100	0,0175°

Table 10. Examples of the Overall Position Error caused by Speed (includes both propagation delay and filter delay)

Speed (rpm)	Total Position Error ($\Delta\theta_{pd} + \Delta\theta_{pf}$)
1000	0,175°
10000	1,75°

7.7 Reduced Power Modes

The AS5130 can be operated in three reduced power modes. All three modes have in common that they switch off or freeze parts of the chip during intervals between measurements. In Low Power Mode or Ultra Low Power Mode, the AS5130 is not operational, but due to the fast start-up, an angle measurement can be accomplished very quickly and the chip can be switched to reduced power immediately after a valid measurement has been taken. Depending on the intervals between measurements, very low average power consumption can be achieved using such a strobed measurement mode.

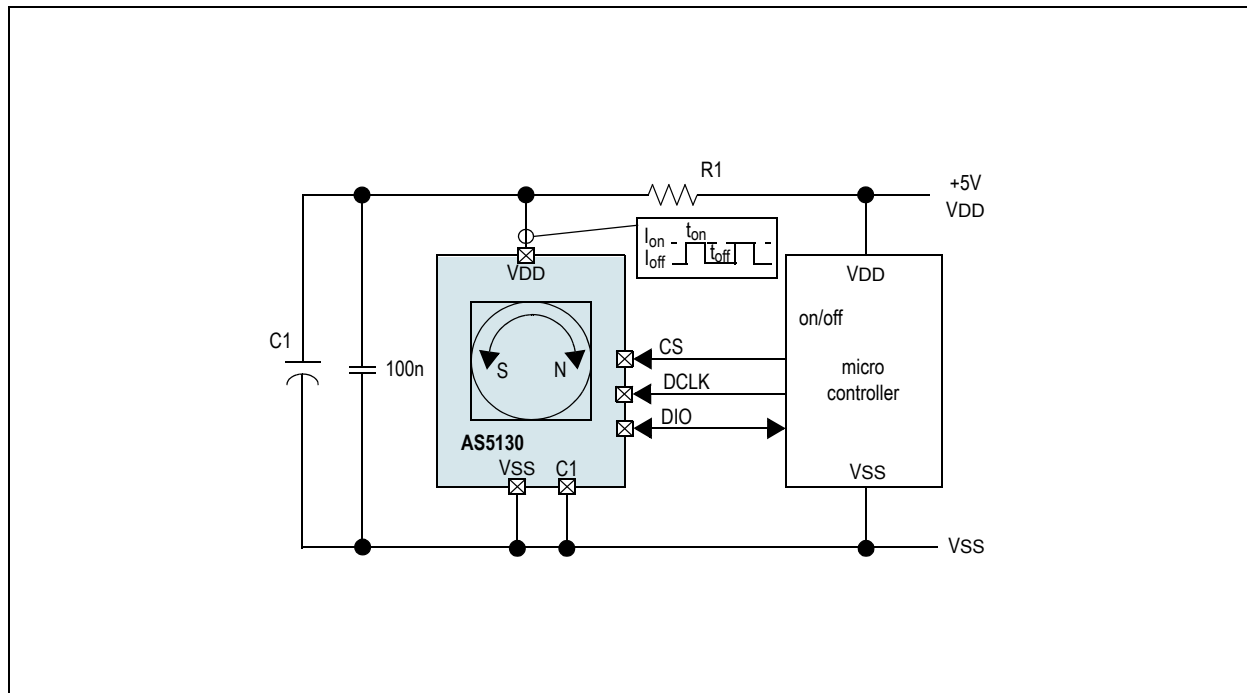
- Low Power Mode: reduced current consumption, very fast start-up. Ideal for short sampling intervals (<3ms).
- Power Cycling mode: zero power consumption (externally switched off) during sampling intervals, but slower start-up than Polling Mode. Ideal for sampling intervals 200ms.
- Polling Mode: for reduction of the average power consumption; especially suited for battery powered applications.

7.7.1 Low Power Mode

The AS5130 can be put in Low Power Mode by simple serial commands, using the regular SSI commands. The required serial command is WRITE CONFIG (17H, [Figure 4 on page 9](#)). The angle data is valid, as soon as the LOCK- Flag is 1 ([see Table 8](#)).

In Reduced Power Modes, the AS5130 is inactive. The last state, e.g. the angle, AGC value, etc. is frozen and the chip starts from this frozen state when it resumes active operation. This method provides much faster start-up than a "cold start" from zero.

Figure 15. Low Power Mode and Ultra Low Power Mode Connection



Mode	Current Consumption (typ)	Wake-up Time to Active Operation
Active Operation	14mA	1.0 ms (without AGC) 3.8 ms(with locked AGC)
Low Power Mode	1,4mA	0.15 ms

If the AS5130 is cycled between active and reduced current mode, a substantial reduction of the average supply current can be achieved. The minimum dwelling time in active mode is the wake-up time. The actual active time depends on how much the magnet has moved while the AS5130 was in reduced power mode. The angle data is valid, when the status bit LOCK has been set (see Table 8). Once a valid angle has been measured, the AS5130 can be put back to reduced power mode. The average power consumption can be calculated as:

$$I_{avg} = \frac{I_{active} * t_{on} + I_{powerdown} * t_{off}}{t_{on} + t_{off}} \quad \text{sampling interval} = t_{on} + t_{off} \quad (EQ 7)$$

Where:

I_{avg} = Average current consumption

I_{active} = Current consumption in active mode

I_{power_down} = Current consumption in reduced power mode

t_{on} = Time period during which the chip is operated in active mode

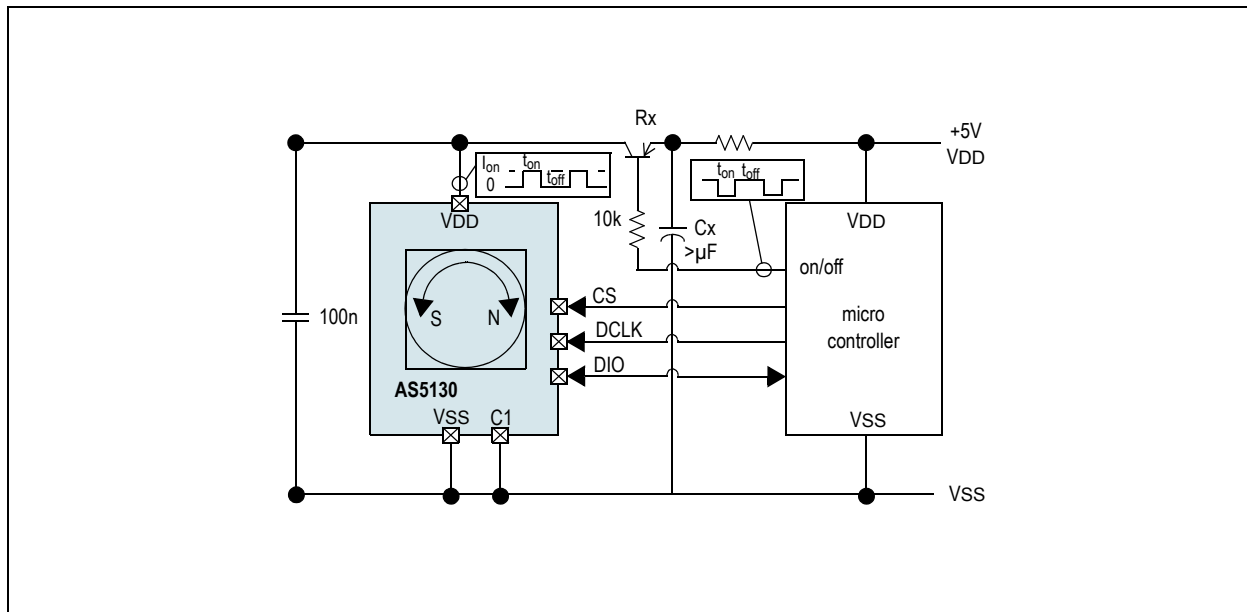
t_{off} = Time period during which the chip is in reduced power mode

Reducing Power Supply Peak Currents. An optional RC-filter (Rx/Cx) may be added to avoid peak currents in the power supply line when the AS5130 is toggled between active and reduced power mode. Rx must be chosen such that it can maintain a VDD voltage of 4.5 – 5.5V under all conditions, especially during long active periods when the charge on Cx has expired. Cx should be chosen such that it can support peak currents during the active operation period. For long active periods, Cx should be large and Rx should be small.

7.7.2 Power Cycling Mode

The power cycling method shown in Figure 16 cycles the AS5130 by switching it on and off, using an external PNP transistor high side switch. The current consumption in off-mode is zero. It also has the longest start-up time of all modes, as the chip must always perform a “cold start” from zero, which takes about 1.9 ms (Compare with Low Power Mode on page 21).

Figure 16. Power Cycling Mode

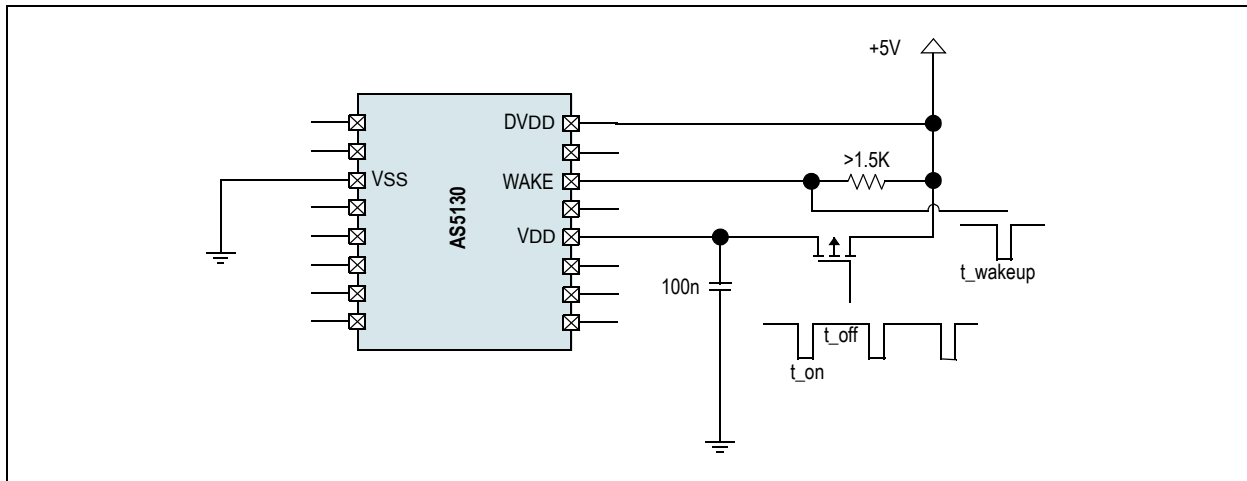


The optional filter Rx/Cx may again be added to reduce peak currents in the 5V power supply line (see Reducing Power Supply Peak Currents on page 22).

7.7.3 Polling Mode

Target of this mode is a reduction of the average power consumption. In this mode, the IC supply is pulsed, thereby reducing the average power consumption to a fraction. The actual angle information and multi turn count value is not lost; polling mode is especially suited for battery powered applications. The IC is furthermore capable of generating a WAKE signal as soon as the magnet's position has changed, but only if the supply of the IC is powered-on again. By means of the WAKE signal, the system's power consumption can be further decreased, if certain modules are activated on demand.

Figure 17. External Circuitry for Polling Mode



The voltage at pin 16 (DVDD) determines whether polling mode is activated or not. Any voltage above 3.6V activates the polling functionality. This voltage must always be present at DVDD in order to hold the information in the registers.

The procedure is as follows:

1. Initial startup: The circuit starts up with invalid trim values, which are read back from the storage registers; the command `rst_otp` (command 19 – 10011) must be sent to read out valid trim values from the OTP.
2. These values are copied to the storage registers if `OTP<8>` (Wake enable) is set (must be set for polling mode).
3. The values of AGC counter, actual angle, multi turn counter, hysteresis setting, wake threshold and gain setting are continuously updated in the storage registers.
4. The actual angle is stored as a reference by sending command `STORE REF` (command 3 – 00011). without this reference angle, a `WAKE` is generated at every startup.
5. The update of the storage registers is stopped if `VDD` drops below 4.45V and then the information is stored (`DVDD`) at the next startup (`VDD` on), the values are read back from the storage registers and the measured angle is compared with the stored reference angle; if the difference between both exceeds the threshold, a `WAKE` pulse is generated.

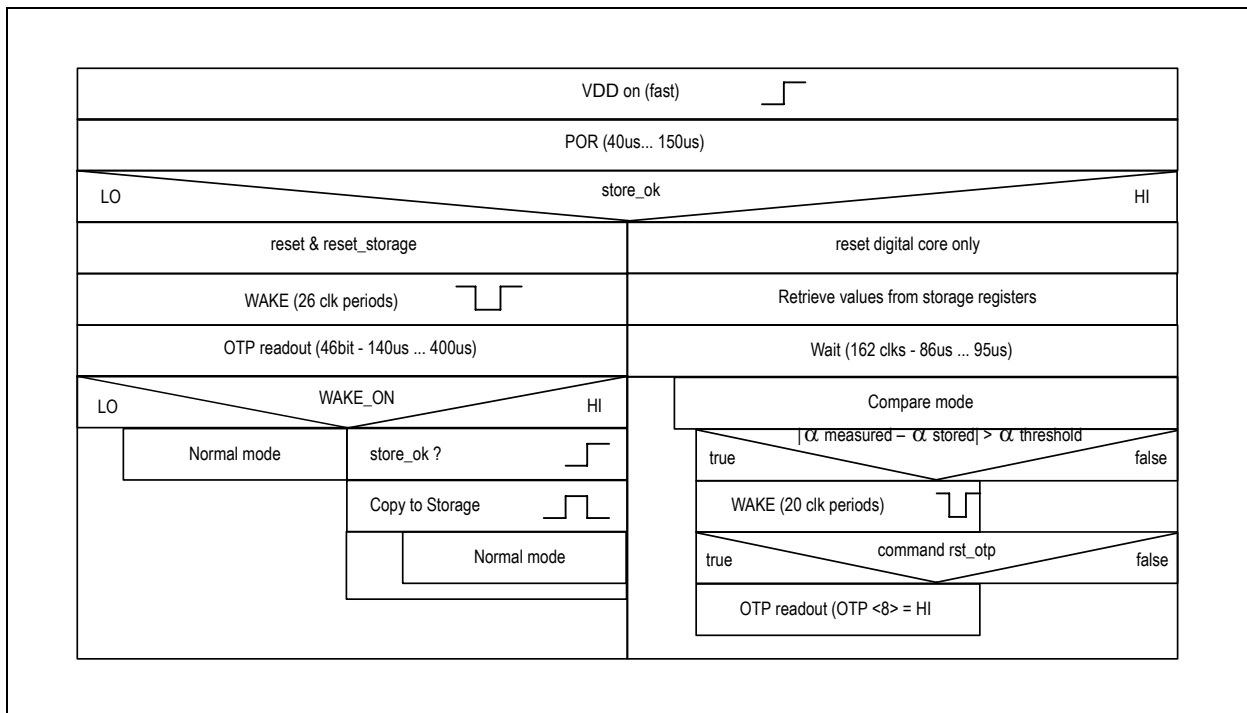
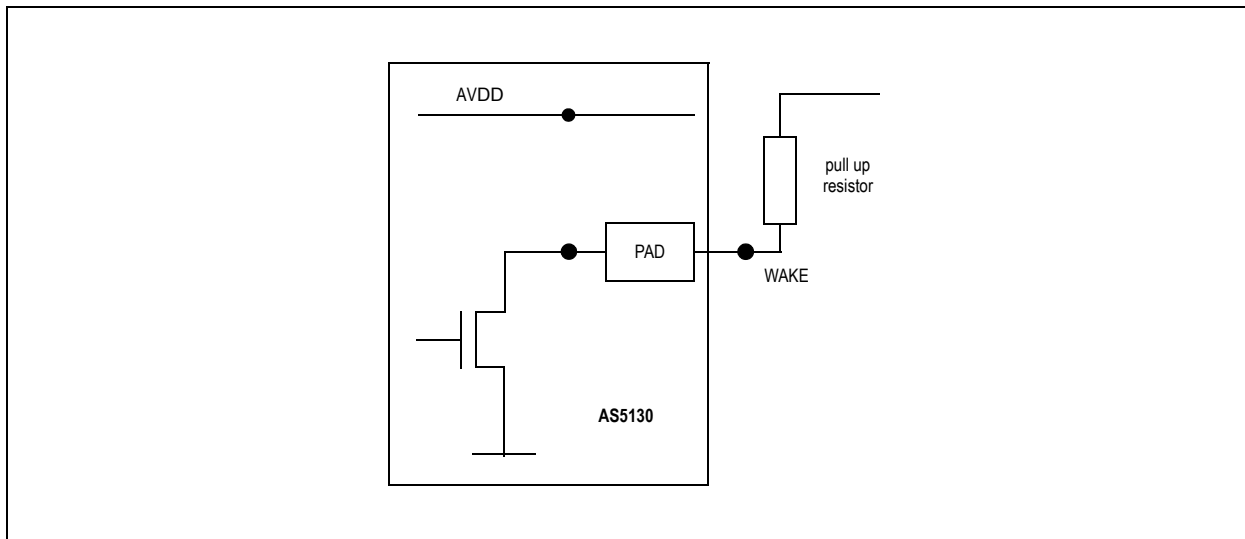


Figure 19 shows the behavior of the wake up signal. The wake up signal will be low for $t_{\text{wakeup}} = 10\mu\text{s}$. After that, the wake up signal will go to tri-state condition. In case of an angle comparison with a result below the threshold, the signal will remain in tri-state condition. After switching on AVDD, the system needs max. 250 μs to generate an angle with maximum accuracy. A WAKE signal cannot be expected until the end of this period.

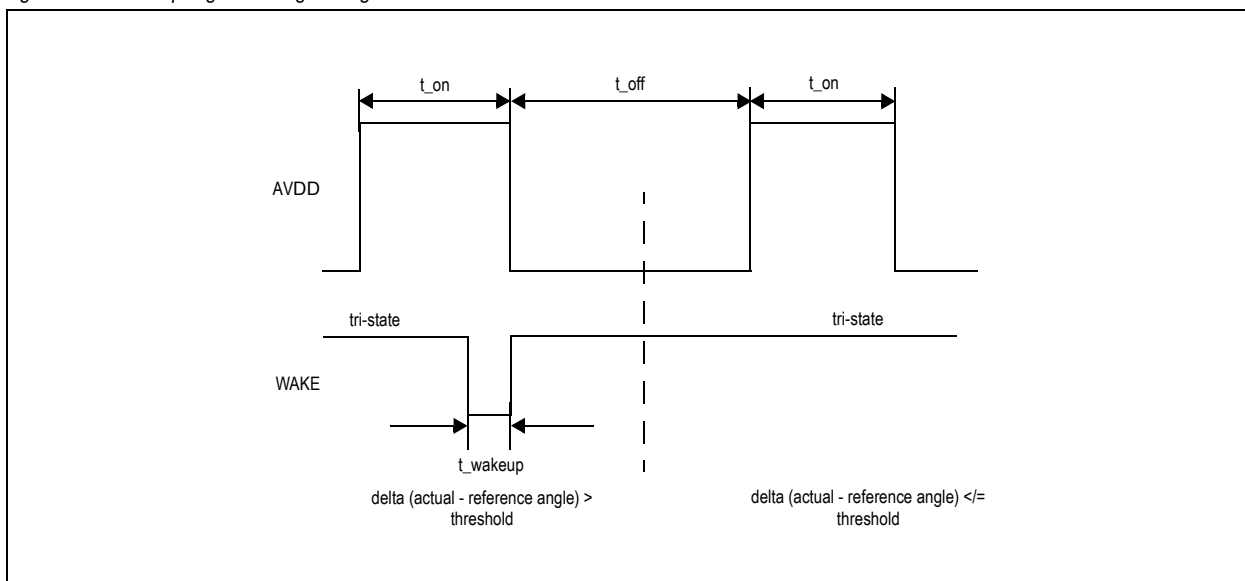
WAKE Interface. An open drain NMOS structure is used in the WAKE pad. In order to generate a clear output signal level, a pull up resistor is required. The pad can drive 4mA.

Figure 18. WAKE Output Pin



Symbol	Parameter	Min	Max	Unit	Notes
$R_{\text{pull_up}}$	Pull up resistor	1.5	100	$k\Omega$	The used pad can drive 4mA.
$t_{\text{wake up}}$	Wake up pulse	10	17	μs	Interrupt signal to external devices, tri-state output, low active.
t_{on}	On-time	250	---	μs	Time for power up in polling mode.
t_{off}	Off-time	---	---	ms	No limit unless DVDD is always supplied.

Figure 19. Wake Up Signal During Polling Mode of AVDD



8 Application Information

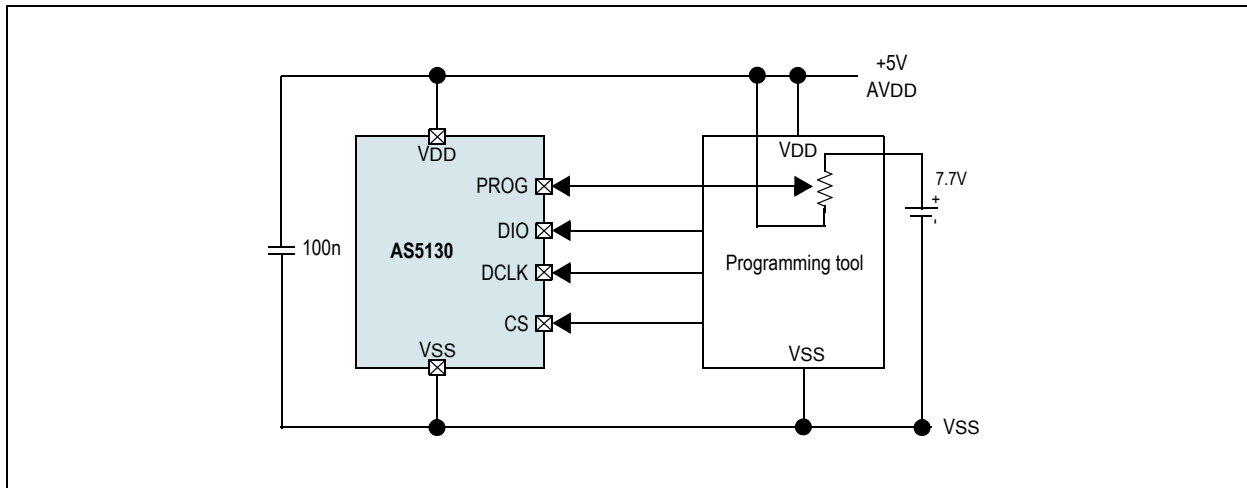
Benefits of AS5130 are as following:

- Complete system-on-chip
- Flexible system solution providing absolute angle position, with serial data and PWM output
- Ideal for applications in harsh environments due to magnetic sensing principle
- High reliability due to non-contact sensing
- Robust system, tolerant to misalignment, airgap variations, temperature variations and external magnetic fields

8.1 Application Example 1

The AS5130 requires the serial interface via SSI for the programming of the OTP register. This configuration is recommended for applications, where the supply voltage for the AS5130 is shared among other parallel IC's during programming, such as a microcontroller.

Figure 20. Programming via SSI Serial Interface



8.2 Application Example II 3-wire sensor with magnetic field strength indication

In Figure 21, a simple 360° sensor with PWM output is shown. The complete application requires only three wires, VDD, VSS and the PWM output. The circle over the center of the chip represents the diametrically polarized magnet. Additionally, the CAO pin will deliver an analog voltage indicating a missing magnetic field. This signal could be used to drive an external LED or to detect an alert signal.

Figure 21. 3-Wire Angle Sensor

